IPC ASSOCIATION CON	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		der both This leve	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfc Information				
upplier In	formation	-							,			<u> </u>			
Company name*			Company unique ID			Ur	Unique ID Authority					Response Date*			
nsemi											2024-04-18				
Contact Name			Title - Contact			Ph	Phone - Contact*				Email - Contact*				
Product-Env-	Stewards		Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com				
uthorized Re	epresentative*		Title - Representative			Ph	Phone - Representative*			Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com				
Red	equester Item Number	Mfr Item	Number	Mfr Item Name		E	Effective Date			V	Weight*	UOM	Unit Type		
				70V, 100mA and 40 Diodes in X2DFNV		tky 2	024-04-18			C).879	mg	Each		
I anufactur	ring Proccess Informa	ation													
Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy J-S	STD-020 MSL Rat	SL Rating Peak Process Body Temperature Max Time at Peak T					Temperati	ure Numb	per of Reflow Cyc	cles		
Matte Tin (Sn) - annealed CU A			CU Alloy	1			260		C	30	secono	ds 3			
omments															
vel 1 - maxin	num time at peak temperat	ture during sol	ldering is 10-3	0 seconds											
or more infor	rmation regarding materia	l composition	please refer to	page 3				· · · · · · · · · · · · · · · · · · ·							

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.015	mg	Supplier	Silicon (Si)	7440-21-3		0.015	mg
Die Attach	0.008	mg		Epoxy resin	proprietary data		0.0012	mg
			Supplier	Silver (Ag)	7440-22-4		0.0064	mg
			Supplier	Bismaleimide	13676-54-5		0.0004	mg
Lead Frame	0.458	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0008	mg
			Supplier	Silicon (Si)	7440-21-3		0.0034	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0005	mg
			В	Nickel (Ni)	7440-02-0		0.0149	mg
			Supplier	Gold (Au)	7440-57-5		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.4384	mg
Mold Compound-Black	0.34	mg	Supplier	Silica Amorphous (SiO2)	7631-86-9		0.0255	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0017	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		0.2703	mg
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		0.017	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.0255	mg
Plating	0.053	mg	Supplier	Tin (Sn)	7440-31-5		0.053	mg
Wire Bond - Cu	0.005	mg	Supplier	Copper (Cu)	7440-50-8		0.005	mg